

MA26V09

Silicon epitaxial planar type

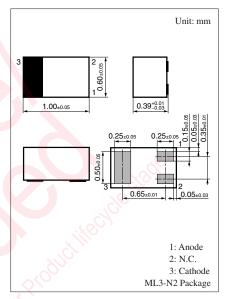
For VCO

Features

- \bullet Good linearity and large capacitance-ratio in $C_D V_R$ relation
- Small series resistance r_D

■ Absolute Maximum Ratings $T_a = 25$ °C

| Parameter | Symbol | Rating | Unit | |
|----------------------|----------------|-------------|------|--|
| Reverse voltage | V_R | 6 | V | |
| Junction temperature | T _j | 125 | °C | |
| Storage temperature | T_{stg} | -55 to +125 | °C | |



Marking Symbol: 2S

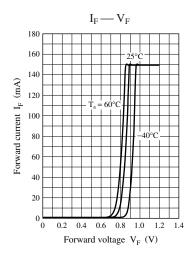
■ Electrical Characteristics $T_a = 25$ °C ± 3°C

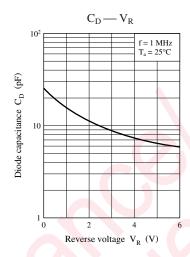
| Symbol | Conditions | Min | Тур | Max | Unit |
|-------------------|---|--|--|--|---|
| I_R | $V_R = 5 \text{ V}$ | 000 | 0,, | 10 | nA |
| C _{D1V} | $V_R = 1 \text{ V, } f = 1 \text{ MHz}$ | 14.9 | 5- | 16.4 | pF |
| C _{D3V} | $V_R = 3 \text{ V, } f = 1 \text{ MHz}$ | 8.4 | | 9.2 | |
| C_{D1V}/C_{D3V} | 95: 67: 10 | 1.69 | | 1.87 | _ |
| r_{D} | $V_R = 3 \text{ V, f} = 470 \text{ MHz}$ | | | 0.35 | Ω |
| | I_{R} C_{D1V} C_{D3V} C_{D1V}/C_{D3V} | $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | $\begin{array}{c ccccccccccccccccccccccccccccccccccc$ |

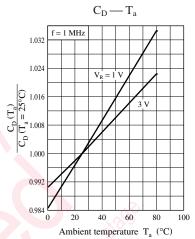
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

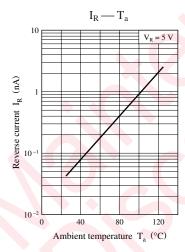
- 2. Absolute frequency of input and output is 470 MHz.
- 3. *: Measuring instrument; YHP MODEL 4191A RF IMPEDANCE ANALYZER

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